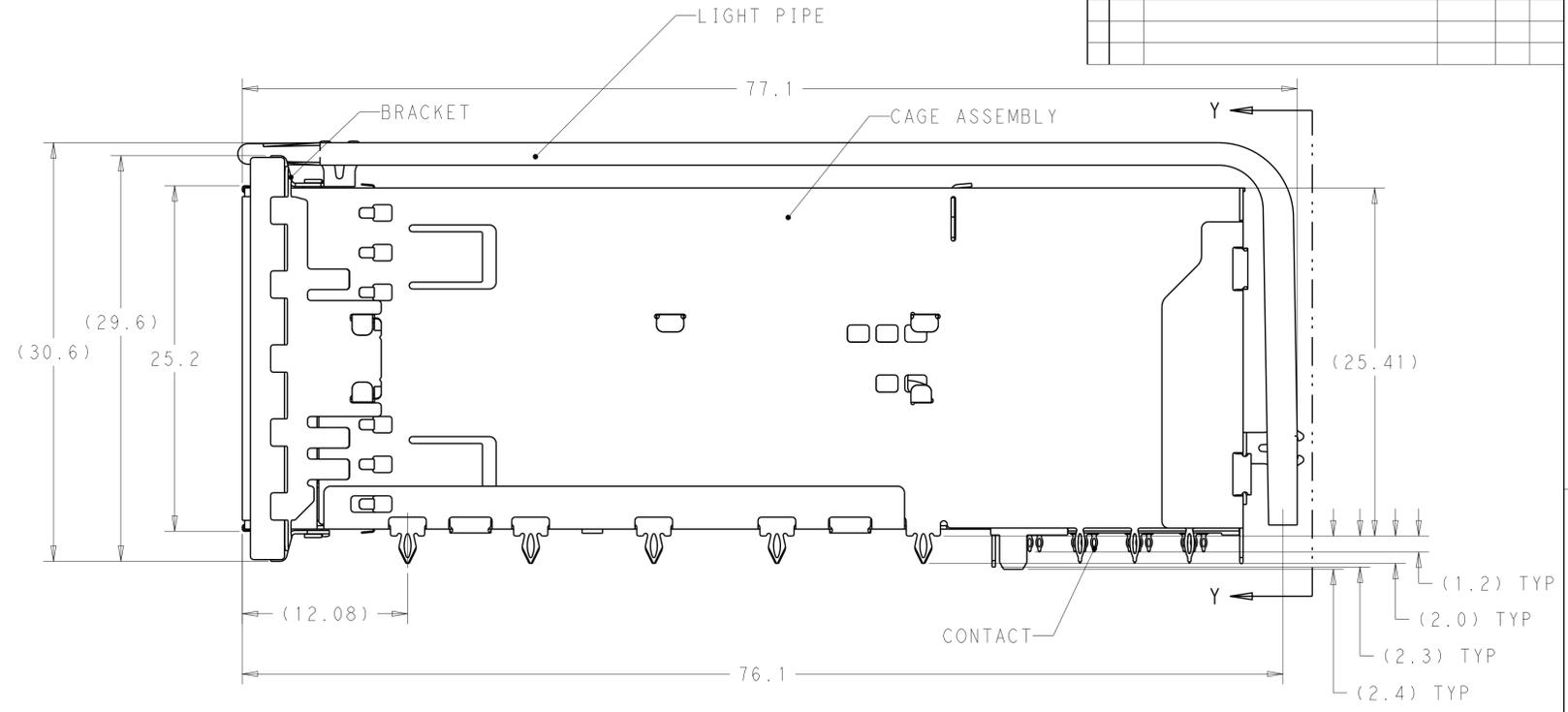
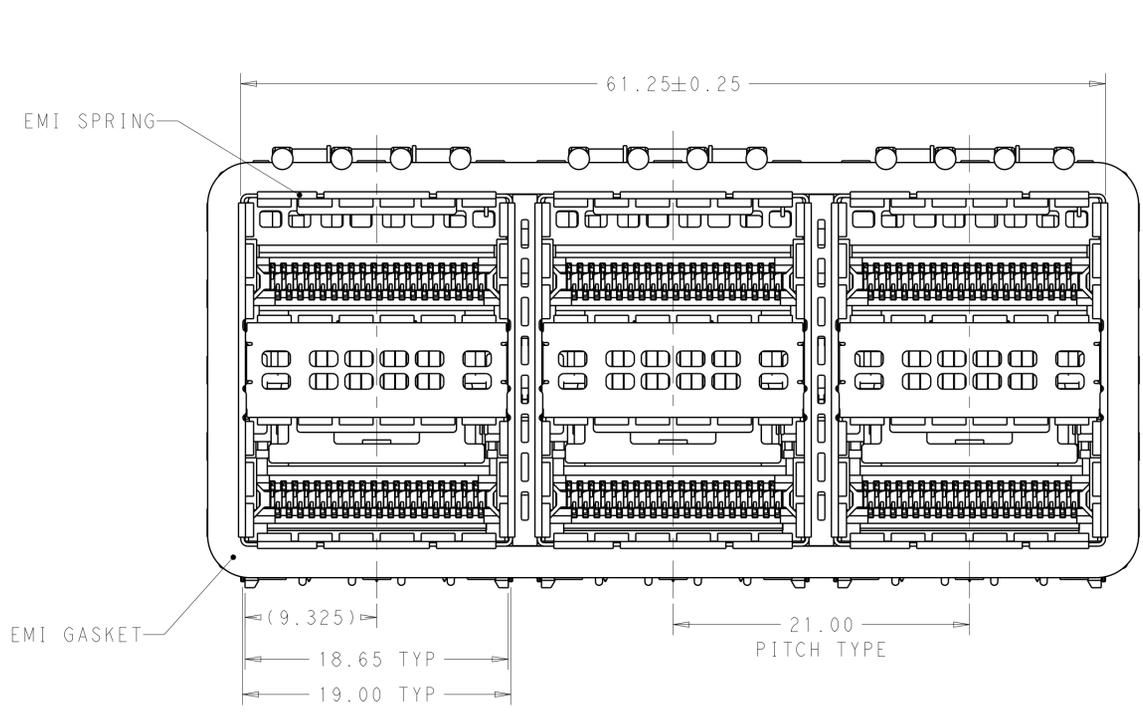
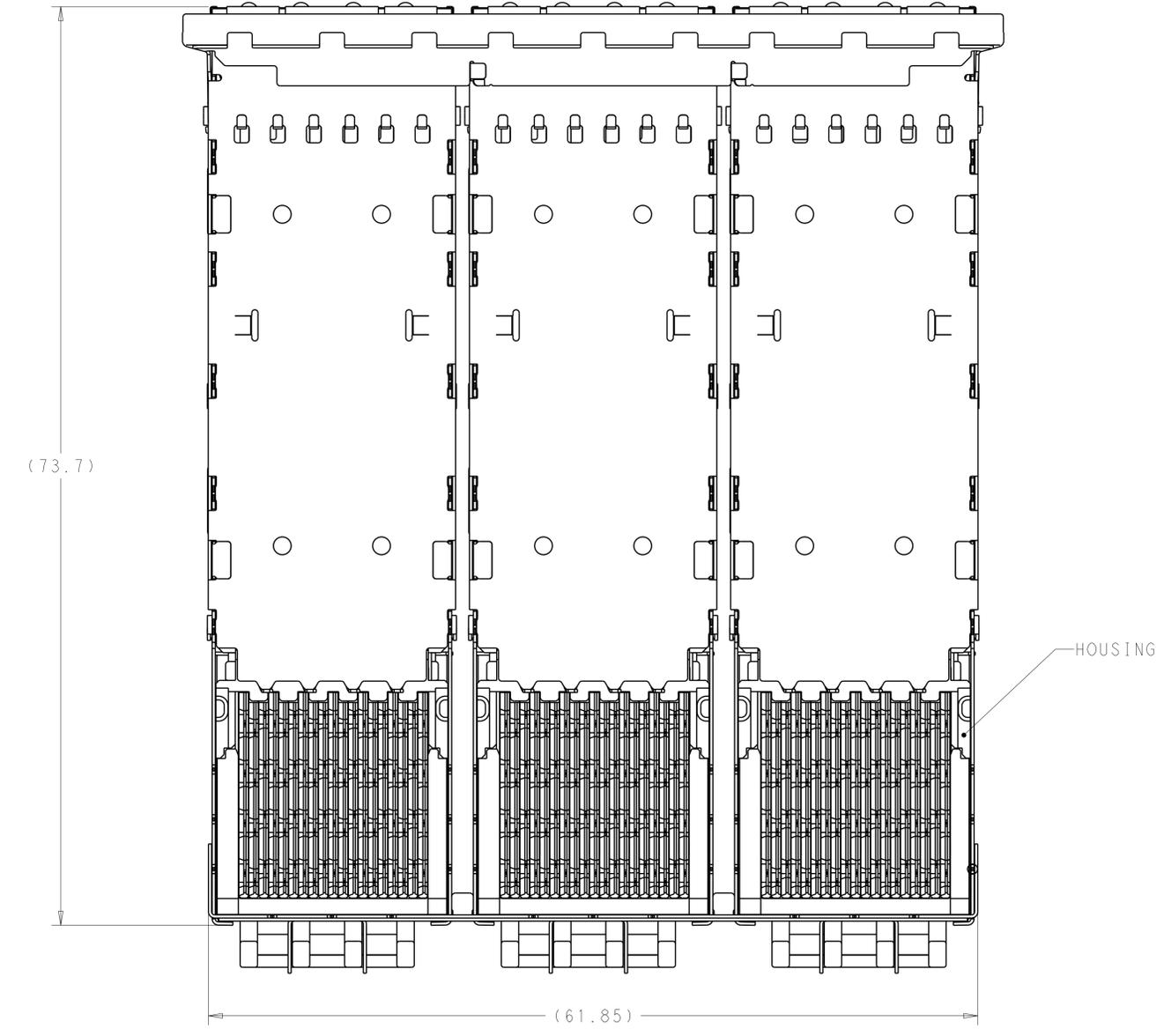


REVISIONS				
P.	LTM	DESCRIPTION	DATE	OWN APVD
A		PROMOTE TO PRODUCTION	04NOV2016	TX SH



2170610-1 AS SHOWN

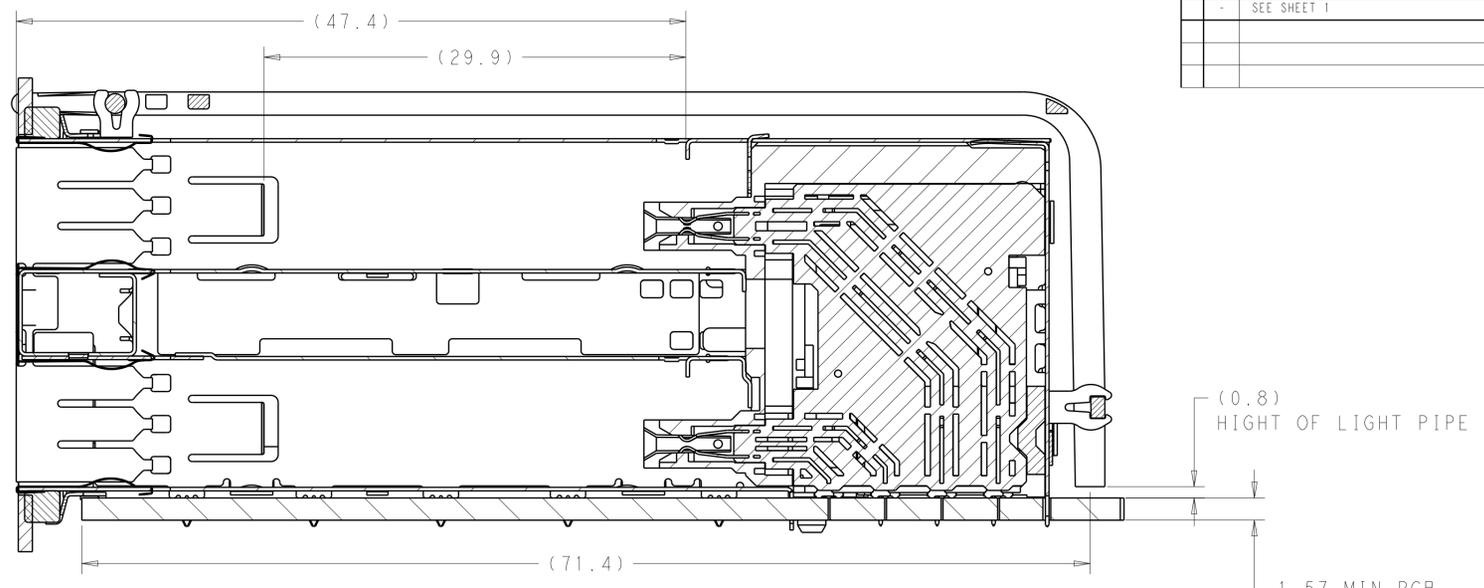
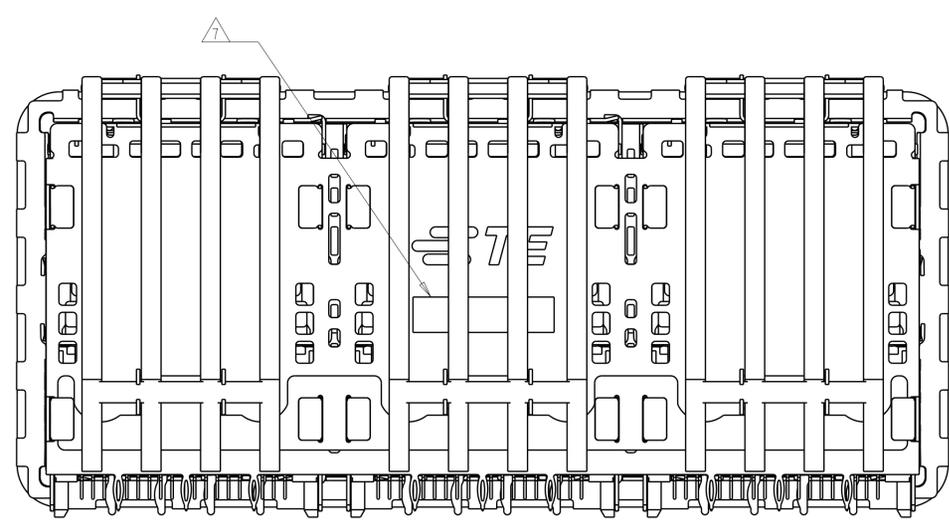


- MATERIALS:
 CAGE ASSEMBLY- NICKEL SILVER ALLOY PER ASTM B 122.
 BRACKET- STAINLESS STEEL.
 EMI SPRING- COPPER ALLOY, NICKEL PLATED.
 EMI GASKET- PLATED FILLED SILICONE WITH 94V-0.
 HOUSING- POLYESTER LCP WITH 94V-0.
 CHICKLET- POLYESTER LCP WITH 94V-0.
 CONTACT- COPPER ALLOY.
 LIGHTPIPE- POLYCARBONATE WITH 94V-0.
- CONTACT FINISH: 0.76µm GOLD ON MATING END, 1.25µm MATT TIN ON SOLDER TAIL, ALL OVER 1.27µm NICKEL.
- DATUM AND BASIC DIMENSION ESTABLISHED BY CUSTOMER.
- MINIMUM PCB THICKNESS: 1.57mm.
- THE ENTIRE AREA OF THE CONNECTOR FOOTPRINT, INDICATED BY THE DASHED LINE, TO BE CONSIDERED THE KEEPOUT AREA FOR COMPONENTS.
- CROSS-HATCHED AREAS REPRESENT ZONES ON THE PCB THAT COME IN CONTACT WITH OR BE IN CLOSE PROXIMITY TO THE PLASTIC HOUSING OR THE CONNECTOR CAGE. INDICATED AREAS TO BE CONSIDERED TRACE FREE.
- PART NUMBER AND DATE CODE MARKED IN APPROXIMATE AREA SHOWN.
- HATCHED AREA IS PLACEMENT ZONE FOR LED. LED SHOULD BE CENTERED WITHIN ZONE. RECOMMEND 0805 PACKAGE.
- CONTACT FINISH: 0.08µm MINIMUM GOLD OVER 0.68µm PALLADIUM-NICKEL ON MATING END, 1.25µm MATT TIN ON SOLDER TAIL, ALL OVER 1.27µm NICKEL.

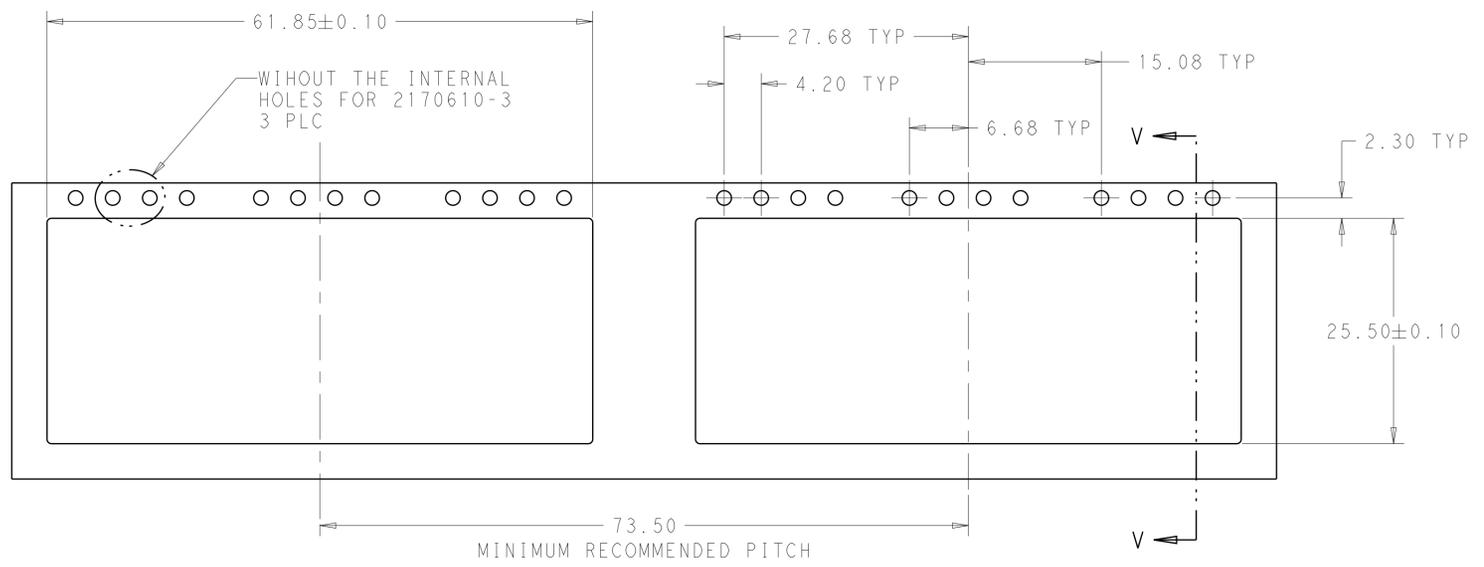
CONTACT FINISHED	DESCRIPTION	PART NUMBER
2	Au PLATING	2170610-3
9	Pd-Ni PLATING	2170610-2
2	Au PLATING	2170610-1

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: REVIN DING 21OCT13	TE Connectivity
DIMENSIONS: mm		CHK: JASON YANG 21OCT13	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: JASON YANG 21OCT13	NAME: CAGE AND CONNECTOR ASSEMBLY, WITH EMI GASKET, 2X3, THERMAL FOOTPRINT, ZQSPF+STACKED PRODUCT SPEC: 108-60102 APPLICATION SPEC: 114-60015 SIZE: CAGE CODE DRAWING NO: A100779 WEIGHT: - CUSTOMER DRAWING
0 PLC ±		PRODUCT SPEC: 108-60102	
1 PLC ±0.25		APPLICATION SPEC: 114-60015	
2 PLC ±0.15		SIZE: CAGE CODE DRAWING NO: A100779	
3 PLC ±		WEIGHT: -	RESTRICTED TO: -
4 PLC ±		SCALE: 4:1	SHEET 1 OF 4
ANGLES ±		REV: A	
FINISH SEE NOTE 2			

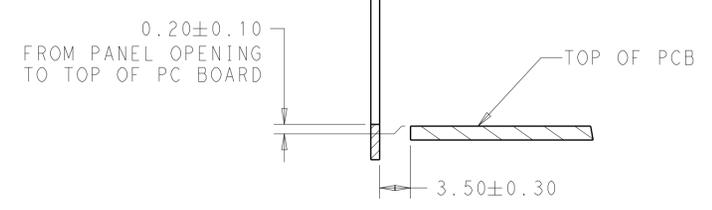
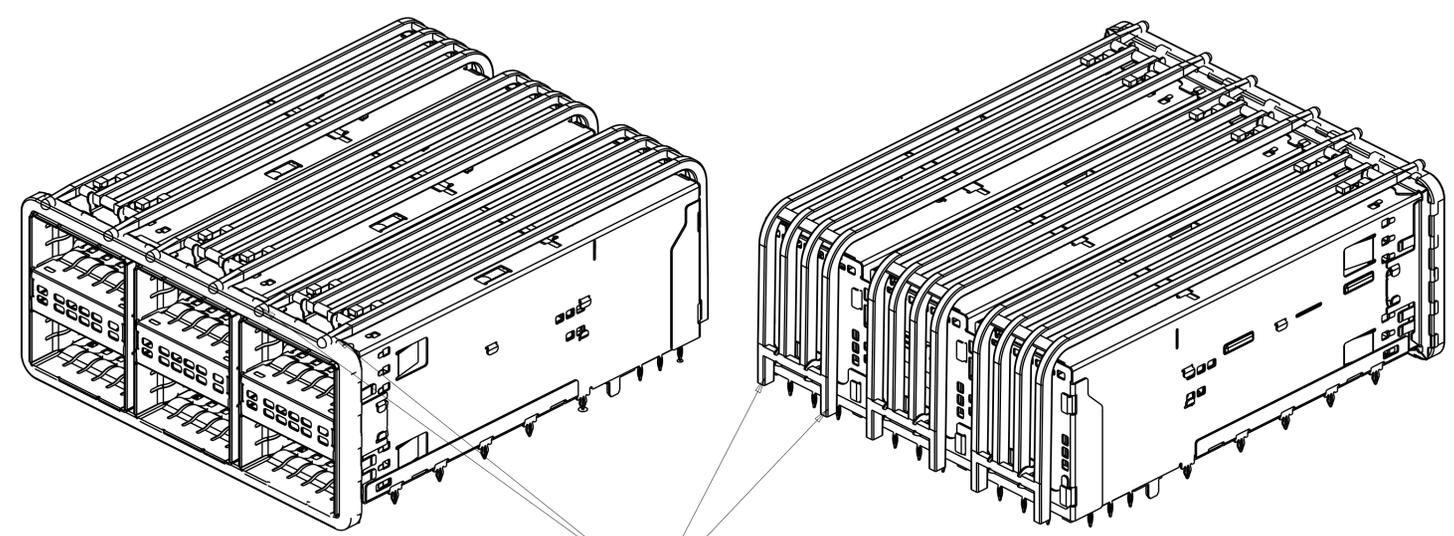
REVISIONS				
P.	LTN.	DESCRIPTION	DATE	APPD.
-	-	SEE SHEET 1	-	-



SECTION V-V
SCALE 4:1



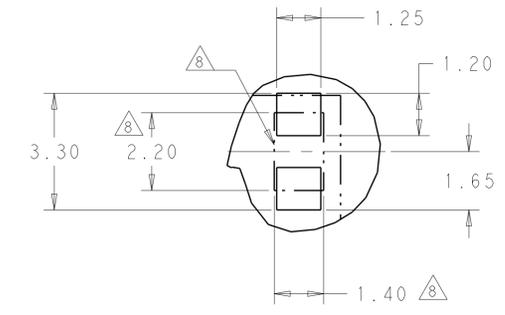
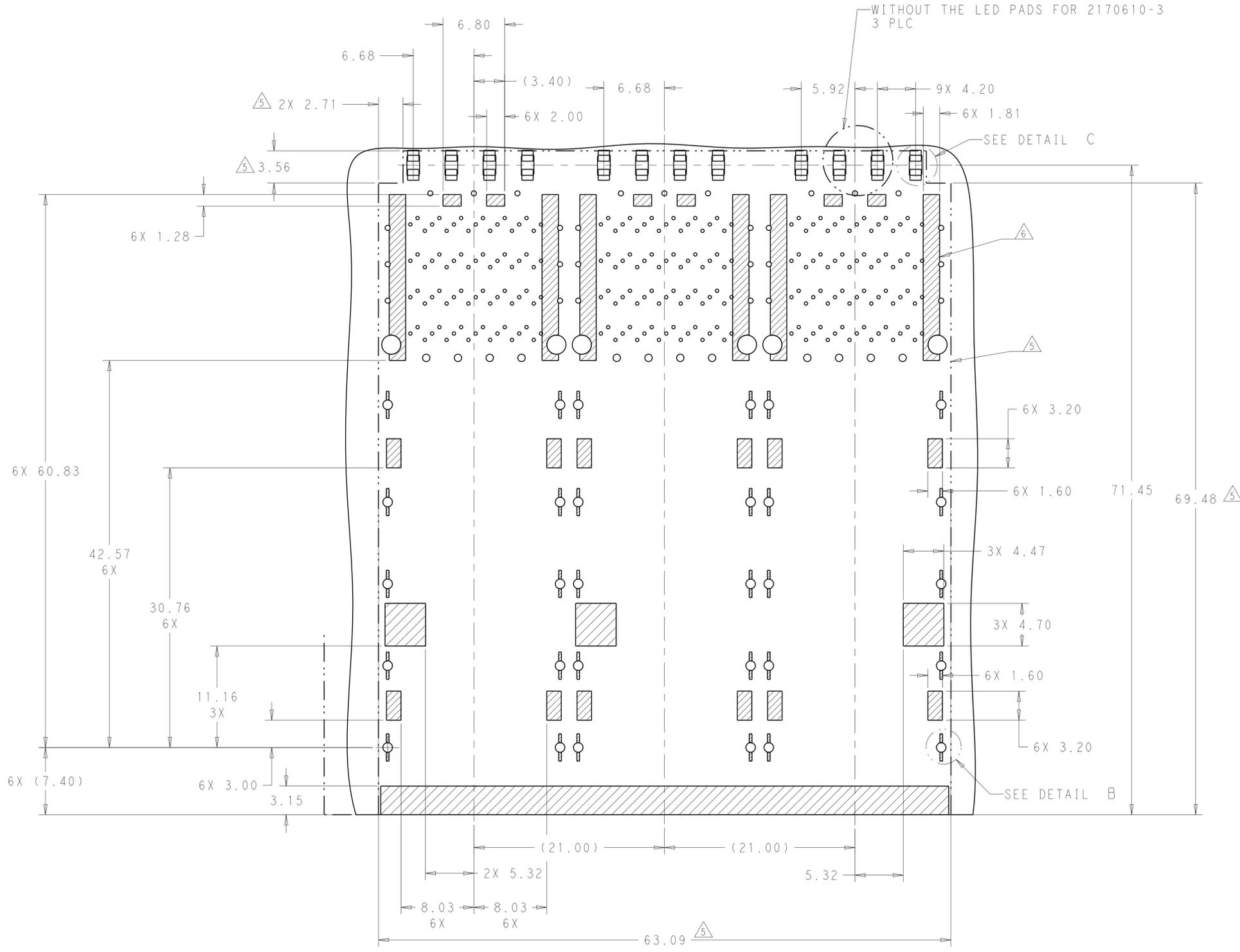
73.50
MINIMUM RECOMMENDED PITCH
RECOMMENDED PANEL CUTOUT
AND PC BOARD, PANEL POSITION



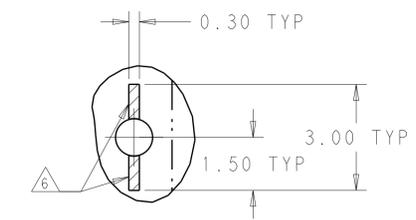
SECTION V-V

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: REVIN DING 21OCT13	TE Connectivity
DIMENSIONS: mm		CHK: JASON YANG 21OCT13	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPD: JASON YANG 21OCT13	NAME: CAGE AND CONNECTOR ASSEMBLY, WITH EMI GASKET, 2X3, THERMAL FOOTPRINT, ZOSFP+STACKED PRODUCT SPEC: 108-60102 APPLICATION SPEC: 114-60015 SIZE: 114-60015 WEIGHT: - CUSTOMER DRAWING
0 PLC ±		NAME: JASON YANG 21OCT13	
1 PLC ±0.25		PRODUCT SPEC: 108-60102	
2 PLC ±0.15		APPLICATION SPEC: 114-60015	
3 PLC ±		SIZE: 114-60015	RESTRICTED TO
4 PLC ±		WEIGHT: -	A100779C=2170610
ANGLES ±		FINISH: SEE NOTE 2	SCALE 4:1 SHEET 2 OF 4 REV A
MATERIAL: SEE NOTE 1		SEE NOTE 2	

REVISIONS				
P.	LTN	DESCRIPTION	DATE	APPD
-	-	SEE SHEET 1	-	-



DETAIL C
SCALE 10:1



DETAIL B
SCALE 10:1

KEEPOUT AREAS
COMPONENT SIDE OF BOARD

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: REVIN DING 210CT13	TE Connectivity
DIMENSIONS: mm		CHK: JASON YANG 210CT13	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPD: JASON YANG 210CT13	NAME: CAGE AND CONNECTOR ASSEMBLY, WITH EMI GASKET, 2X3, THERMAL FOOTPRINT, ZQSFP+STACKED
0 PLC ± 1 PLC ±0.25 2 PLC ±0.15 3 PLC ± 4 PLC ± ANGLES ±2°		PRODUCT SPEC: 108-60102	SIZE: 114-60015
MATERIAL: SEE NOTE 1		APPLICATION SPEC: 114-60015	RESTRICTED TO: A100779C=2170610
FINISH: SEE NOTE 2		WEIGHT: -	SCALE: 4:1 SHEET 4 OF 4 REV A
		CUSTOMER DRAWING	

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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